



Welcome to [E-XFL.COM](https://www.e-xfl.com)

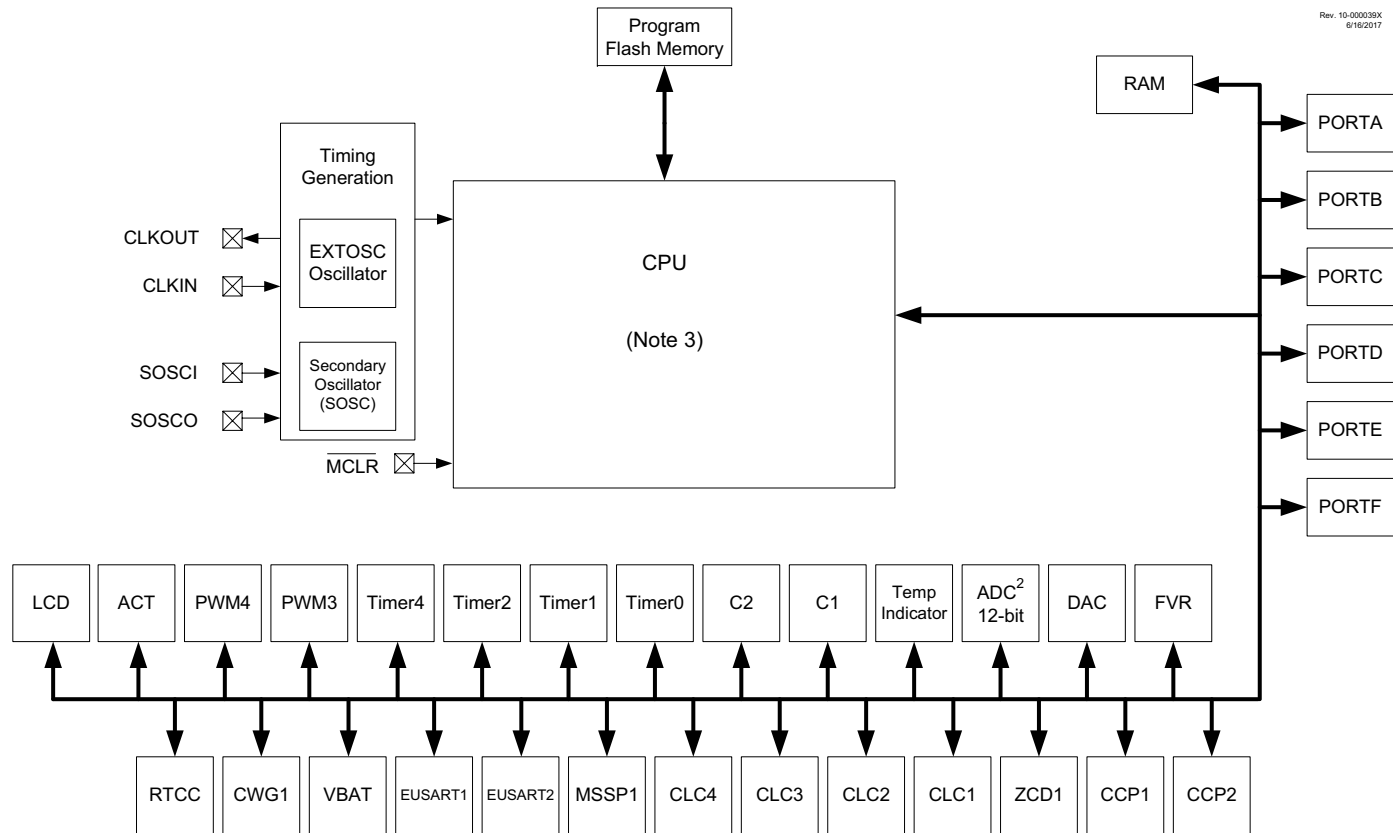
What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 20x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f19155t-i-so

FIGURE 1-1: PIC16(L)F19155/56/75/76/85/86 BLOCK DIAGRAM

Note 1: See applicable chapters for more information on peripherals.

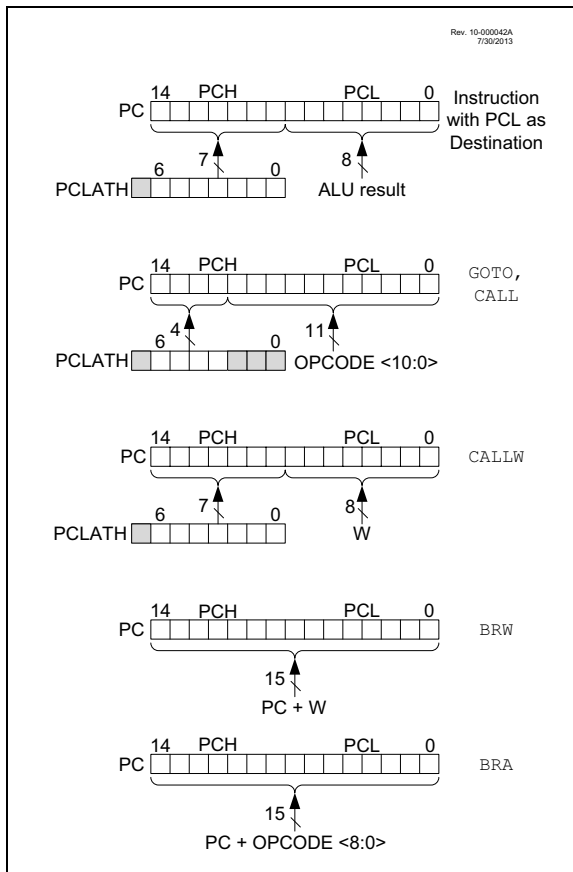
2: See Table 1-1 for peripherals available on specific devices.

3: See Figure 3-1.

4.4 PCL and PCLATH

The Program Counter (PC) is 15 bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<14:8>) is not directly readable or writable and comes from PCLATH. On any Reset, the PC is cleared. Figure 4-3 shows the five situations for the loading of the PC.

FIGURE 4-3: LOADING OF PC IN DIFFERENT SITUATIONS



4.4.1 MODIFYING PCL

Executing any instruction with the PCL register as the destination simultaneously causes the Program Counter PC<14:8> bits (PCH) to be replaced by the contents of the PCLATH register. This allows the entire contents of the program counter to be changed by writing the desired upper seven bits to the PCLATH register. When the lower eight bits are written to the PCL register, all 15 bits of the program counter will change to the values contained in the PCLATH register and those being written to the PCL register.

4.4.2 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When performing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block). Refer to Application Note AN556, "Implementing a Table Read" (DS00556).

4.4.3 COMPUTED FUNCTION CALLS

A computed function CALL allows programs to maintain tables of functions and provide another way to execute state machines or look-up tables. When performing a table read using a computed function CALL, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block).

If using the CALL instruction, the PCH<2:0> and PCL registers are loaded with the operand of the CALL instruction. PCH<6:3> is loaded with PCLATH<6:3>.

The CALLW instruction enables computed calls by combining PCLATH and W to form the destination address. A computed CALLW is accomplished by loading the W register with the desired address and executing CALLW. The PCL register is loaded with the value of W and PCH is loaded with PCLATH.

4.4.4 BRANCHING

The branching instructions add an offset to the PC. This allows relocatable code and code that crosses page boundaries. There are two forms of branching, BRW and BRA. The PC will have incremented to fetch the next instruction in both cases. When using either branching instruction, a PCL memory boundary may be crossed.

If using BRW, load the W register with the desired unsigned address and execute BRW. The entire PC will be loaded with the address PC + 1 + W.

If using BRA, the entire PC will be loaded with PC + 1 + the signed value of the operand of the BRA instruction.

PIC16(L)F19155/56/75/76/85/86

REGISTER 12-2: WDTCON1: WATCHDOG TIMER CONTROL REGISTER 1

U-0	R/W ⁽³⁾ -q/q ⁽¹⁾	R/W ⁽³⁾ -q/q ⁽¹⁾	R/W ⁽³⁾ -q/q ⁽¹⁾	U-0	R/W ⁽⁴⁾ -q/q ⁽²⁾	R/W ⁽⁴⁾ -q/q ⁽²⁾	R/W ⁽⁴⁾ -q/q ⁽²⁾
—	WDTCS<2:0>			—	WINDOW<2:0>		
bit 7				bit 0			

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **WDTCS<2:0>:** Watchdog Timer Clock Select bits

111 = Reserved

•
•
•

010 = SOSC 32.768 kHz

001 = MFINTOSC 31.25 kHz

000 = LFINTOSC 31 kHz

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **WINDOW<2:0>:** Watchdog Timer Window Select bits

WINDOW<2:0>	Window delay Percent of time	Window opening Percent of time
111	N/A	100
110	12.5	87.5
101	25	75
100	37.5	62.5
011	50	50
010	62.5	37.5
001	75	25
000	87.5	12.5

Note 1: If WDTCCS <2:0> in CONFIG3 = 111, the Reset value of WDTCS<2:0> is 000.

2: The Reset value of WINDOW<2:0> is determined by the value of WDTCWS<2:0> in the CONFIG3 register.

3: If WDTCCS<2:0> in CONFIG3 ≠ 111, these bits are read-only.

4: If WDTCWS<2:0> in CONFIG3 ≠ 111, these bits are read-only.

PIC16(L)F19155/56/75/76/85/86

REGISTER 14-5: WPUA: WEAK PULL-UP PORTA REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
WPUA7	WPUA6	WPUA5 ⁽²⁾	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **WPUA<7:0>**: Weak Pull-up Register bits⁽¹⁾

1 = Pull-up enabled

0 = Pull-up disabled

Note 1: The weak pull-up device is automatically disabled if the pin is configured as an output.

2: Bit not used when $\overline{VBATEN} = 0$.

REGISTER 14-6: ODCONA: PORTA OPEN-DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODCA7	ODCA6	—	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-6 **ODCA<7:6>**: PORTA Open-Drain Enable bits

For RA<7:6> pins, respectively

1 = Port pin operates as open-drain drive (sink current only)

0 = Port pin operates as standard push-pull drive (source and sink current)

bit 5 **Unimplemented:** Read as '0'

bit 4-0 **ODCA<4:0>**: PORTA Open-Drain Enable bits

For RA<4:0> pins, respectively

1 = Port pin operates as open-drain drive (sink current only)

0 = Port pin operates as standard push-pull drive (source and sink current)

PIC16(L)F19155/56/75/76/85/86

REGISTER 19-2: ADCON1: ADC CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	U-0	R/W-0/0
PPOL	IPEN	GPOL	—	—	—	—	DSEN
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7

PPOL: Precharge Polarity bit

If PRE>0x00:

PPOL	Action During 1st Precharge Stage	
	External (selected analog I/O pin)	Internal (AD sampling capacitor)
1	Connected to VDD	C _{HOLD} connected to VSS
0	Connected to VSS	C _{HOLD} connected to VDD

Otherwise:

The bit is ignored

bit 6

IPEN: A/D Inverted Precharge Enable bit

If DSEN = 1

1 = The precharge and guard signals in the second conversion cycle are the opposite polarity of the first cycle

0 = Both Conversion cycles use the precharge and guards specified by ADPPOL and ADGPOL

Otherwise:

The bit is ignored

bit 5

GPOL: Guard Ring Polarity Selection bit

1 = ADC guard Ring outputs start as digital high during Precharge stage

0 = ADC guard Ring outputs start as digital low during Precharge stage

bit 4-1

Unimplemented: Read as '0'

bit 0

DSEN: Double-sample enable bit

1 = Two conversions are performed on each trigger. Data from the first conversion appears in PREV

0 = One conversion is performed for each trigger

PIC16(L)F19155/56/75/76/85/86

REGISTER 19-3: ADCON2: ADC CONTROL REGISTER 2

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W/HC-0	R/W-0/0	R/W-0/0	R/W-0/0
PSIS	CRS<2:0>			ACLR	MD<2:0>		
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

- bit 7 **PSIS:** ADC Previous Sample Input Select bits
1 = PREV is the FLTR value at start-of-conversion
0 = PREV is the RES value at start-of-conversion
- bit 6-4 **CRS<2:0>:** ADC Accumulated Calculation Right Shift Select bits
If ADMD = 100:
Low-pass filter time constant is 2^{ADCRS} , filter gain is 1:1
If ADMD = 001, 010 or 011:
The accumulated value is right-shifted by CRS (divided by 2^{ADCRS})(1,2)
Otherwise:
Bits are ignored
- bit 3 **ACLR:** A/D Accumulator Clear Command bit⁽³⁾
1 = ACC, AOV and CNT registers are cleared
0 = Clearing action is complete (or not started)
- bit 2-0 **MD<2:0>:** ADC Operating Mode Selection bits⁽⁴⁾
111-101 = Reserved
100 = Low-pass Filter mode
011 = Burst Average mode
010 = Average mode
001 = Accumulate mode
000 = Basic mode

- Note 1:** To correctly calculate an average, the number of samples (set in RPT) must be 2^{ADCRS} .
- 2:** ADCRS = 3 'b111 is a reserved option.
- 3:** This bit is cleared by hardware when the accumulator operation is complete; depending on oscillator selections, the delay may be many instructions.
- 4:** See Table 19-2 for Full mode descriptions.

PIC16(L)F19155/56/75/76/85/86

REGISTER 19-9: ADPREL: ADC PRECHARGE TIME CONTROL REGISTER (LOW BYTE)

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PRE<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **PRE<7:0>**: Precharge Time Select bits
See Table 19-4.

REGISTER 19-10: ADPREH: ADC PRECHARGE TIME CONTROL REGISTER (HIGH BYTE)

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	PRE<12:8>				
bit 7				bit 0			

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 **Unimplemented**: Read as '0'
bit 4-0 **PRE<12:8>**: Precharge Time Select bits⁽¹⁾
See Table 19-4.

Note: If PRE is not equal to '0', then ADACQ = b'00000000 means Acquisition time is 256 clocks of the selected ADC clock.

TABLE 19-4: PRECHARGE TIME

ADPRE	Precharge time
1 1111 1111 1111	8191 clocks of the selected ADC clock
1 1111 1111 1110	8190 clocks of the selected ADC clock
1 1111 1111 1101	8189 clocks of the selected ADC clock
...	...
0 0000 0000 0010	2 clocks of the selected ADC clock
0 0000 0000 0001	1 clock of the selected ADC clock
0 0000 0000 0000	Not included in the data conversion cycle

20.2.1 CALIBRATION

20.2.1.1 Single-Point Calibration

Single-point calibration is performed by application software using Equation 20-1 and the assumed M_t . A reading of V_{TSENSE} at a known temperature is taken, and the theoretical temperature is calculated by temporarily setting $TOFFSET = 0$. Then $TOFFSET$ is computed as the difference of the actual and calculated temperatures. Finally, $TOFFSET$ is stored in nonvolatile memory within the device, and is applied to future readings to gain a more accurate measurement.

20.2.1.2 Higher-Order Calibration

If the application requires more precise temperature measurement, additional calibrations steps will be necessary. For these applications, two-point or three-point calibration is recommended.

Note 1: The $TOFFSET$ value may be determined by the user with a temperature test.

2: Although the measurement range is -40°C to $+125^{\circ}\text{C}$, due to the variations in offset error, the single-point uncalibrated calculated $TSENSE$ value may indicate a temperature from -140°C to $+225^{\circ}\text{C}$, before the calibration offset is applied.

3: The user must take into consideration self-heating of the device at different clock frequencies and output pin loading. For package related thermal characteristics information, refer to Table 39-13.

20.2.2 TEMPERATURE RESOLUTION

The resolution of the ADC reading, Ma ($^{\circ}\text{C}/\text{count}$), depends on both the ADC resolution N and the reference voltage used for conversion, as shown in Equation 20-2. It is recommended to use the smallest V_{REF} value, such as 2.048 FVR reference voltage, instead of V_{DD} .

Note: Refer to Table 39-17 for FVR reference voltage accuracy.

EQUATION 20-2: TEMPERATURE RESOLUTION ($^{\circ}\text{C}/\text{LSb}$)

$$Ma = \frac{V_{REF}}{2^N} \times Mt$$

$$Ma = \frac{V_{REF}}{2^N} \times \frac{1}{Mv}$$

Where:

Mv = sensor voltage sensitivity ($\text{V}/^{\circ}\text{C}$)

V_{REF} = Reference voltage of the ADC module (in Volts)

N = Resolution of the ADC

The typical Mv value for a single diode is approximately -1.267 to -1.32 $\text{mV}/^{\circ}\text{C}$.

The typical Mv value for a stack of two diodes (Low Range setting) is approximately -2.533 $\text{mV}/^{\circ}\text{C}$.

The typical Mv value for a stack of three diodes (High range setting) is approximately -3.8 $\text{mV}/^{\circ}\text{C}$.

20.3 ADC Acquisition Time

To ensure accurate temperature measurements, the user must wait a minimum of $25\ \mu\text{s}$ for the ADC value to settle, after the ADC input multiplexer is connected to the temperature indicator output, before the conversion is performed.

20.4 Minimum Operating VDD

When the temperature circuit is operated in Low range, the device may be operated at any operating voltage that is within specifications. When the temperature circuit is operated in High range, the device operating voltage, VDD, must be high enough to ensure that the temperature circuit is correctly biased.

Table 20-1 shows the recommended minimum VDD vs. Range setting.

TABLE 20-1: RECOMMENDED VDD vs. RANGE

Min.VDD, TSRNG = 1 (High Range)	Min. VDD, TSRNG = 0 (Low Range)
≥ 2.5	≥ 1.8

20.5 Temperature Indicator Range

The temperature indicator circuit operates in either High or Low range. The High range, selected by setting the TSRNG bit of the FVRCON register, provides a wider output voltage. This provides more resolution over the temperature range. High range requires a higher-bias voltage to operate and thus, a higher VDD is needed. The Low range is selected by clearing the TSRNG bit of the FVRCON register. The Low range generates a lower sensor voltage and thus, a lower VDD voltage is needed to operate the circuit.

The output voltage of the sensor is the highest value at -40°C and the lowest value at +125°C.

- **High Range:** The High range is used in applications with the reference for the ADC, VREF = 2.048V. This range may not be suitable for battery-powered applications.
- **Low Range:** This mode is useful in applications in which the VDD is too low for high-range operation. The VDD in this mode can be as low as 1.8V. VDD must, however, be at least 0.5V higher than the maximum sensor voltage depending on the expected low operating temperature.

20.6 DIA Information

DIA data provide ADC readings at one operating temperature. DIA data is taken during factory testing and stored within the device. The 90°C reading alone allows single-point calibration as described in Section 20.2.1, Calibration, by solving Equation 20-1 for TOFFSET.

Refer to **Section 6.0 “Device Information Area”** for more information on the data stored in the DIA and how to access them.

Note: The lower temperature range (e.g., -40°C) will suffer in accuracy because temperature conversion must extrapolate below the reference points, amplifying any measurement errors.

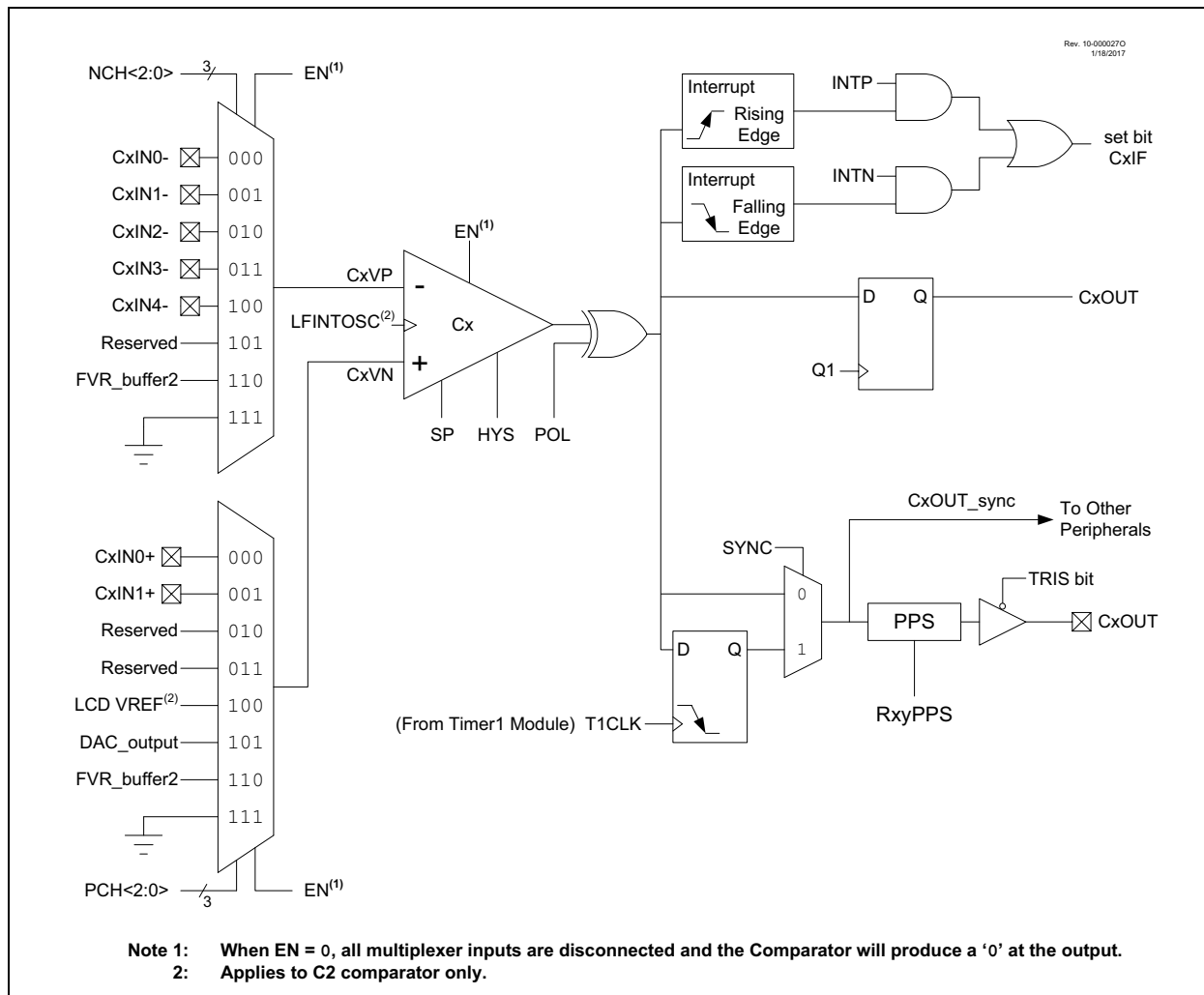
TABLE 20-2: SUMMARY OF REGISTERS ASSOCIATED WITH THE TEMPERATURE INDICATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDFVR<1:0>		ADFVR<1:0>		285

Legend: — = Unimplemented location, read as '0'. Shaded cells are unused by the temperature indicator module.

PIC16(L)F19155/56/75/76/85/86

FIGURE 22-2: COMPARATOR MODULE SIMPLIFIED BLOCK DIAGRAM



PIC16(L)F19155/56/75/76/85/86

REGISTER 24-8: MINUTES⁽¹⁾: MINUTE VALUE REGISTER

U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	MINH<2:0>			MINL<3:0>			
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **MINH<2:0>:** Binary Coded Decimal value of minutes '10' digit; valid values from 0 to 5

bit 3-0 **MINL<3:0>:** Binary Coded Decimal value of minutes '1' digit; valid values from 0 to 9

Note 1: Writes to the MINUTE registers are only allowed when RTCWREN = 1.

REGISTER 24-9: SECONDS⁽¹⁾: SECOND VALUE REGISTER

U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	SECH<2:0>			SECL<3:0>			
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **SECH<2:0>:** Binary Coded Decimal value of seconds '10' digit; valid values from 0 to 5

bit 3-0 **SECL<3:0>:** Binary Coded Decimal value of seconds '1' digit; valid values from 0 to 9

Note 1: Writes to the SECOND registers are only allowed when RTCWREN = 1.

FIGURE 26-4: TIMER1 GATE TOGGLE MODE

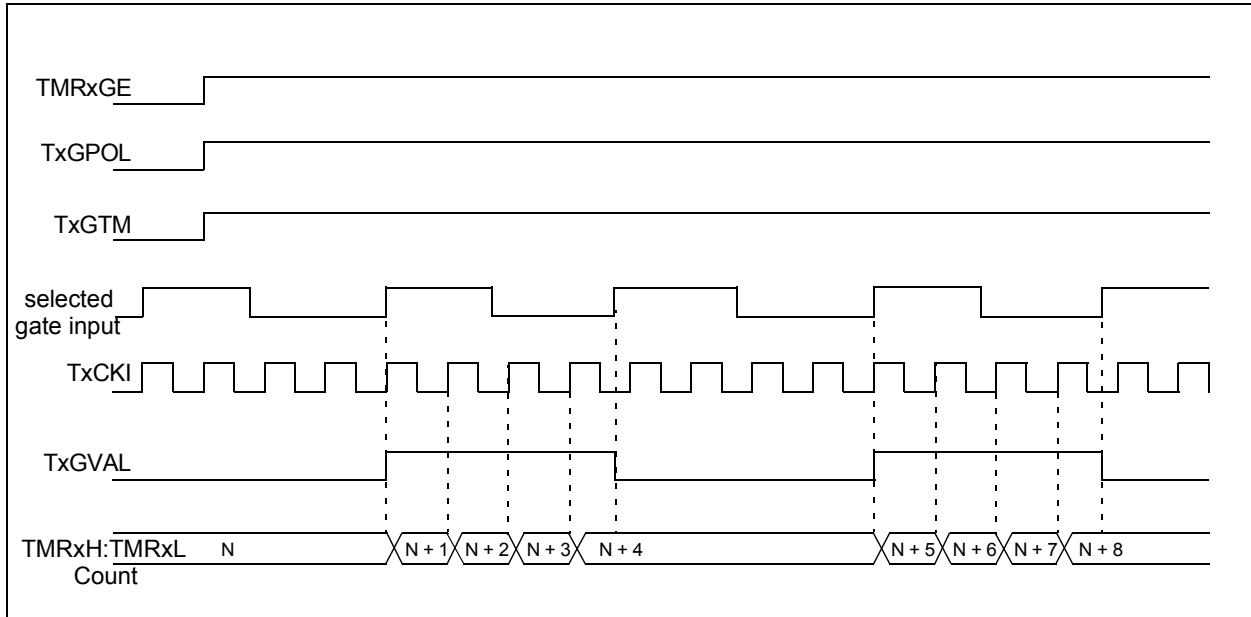
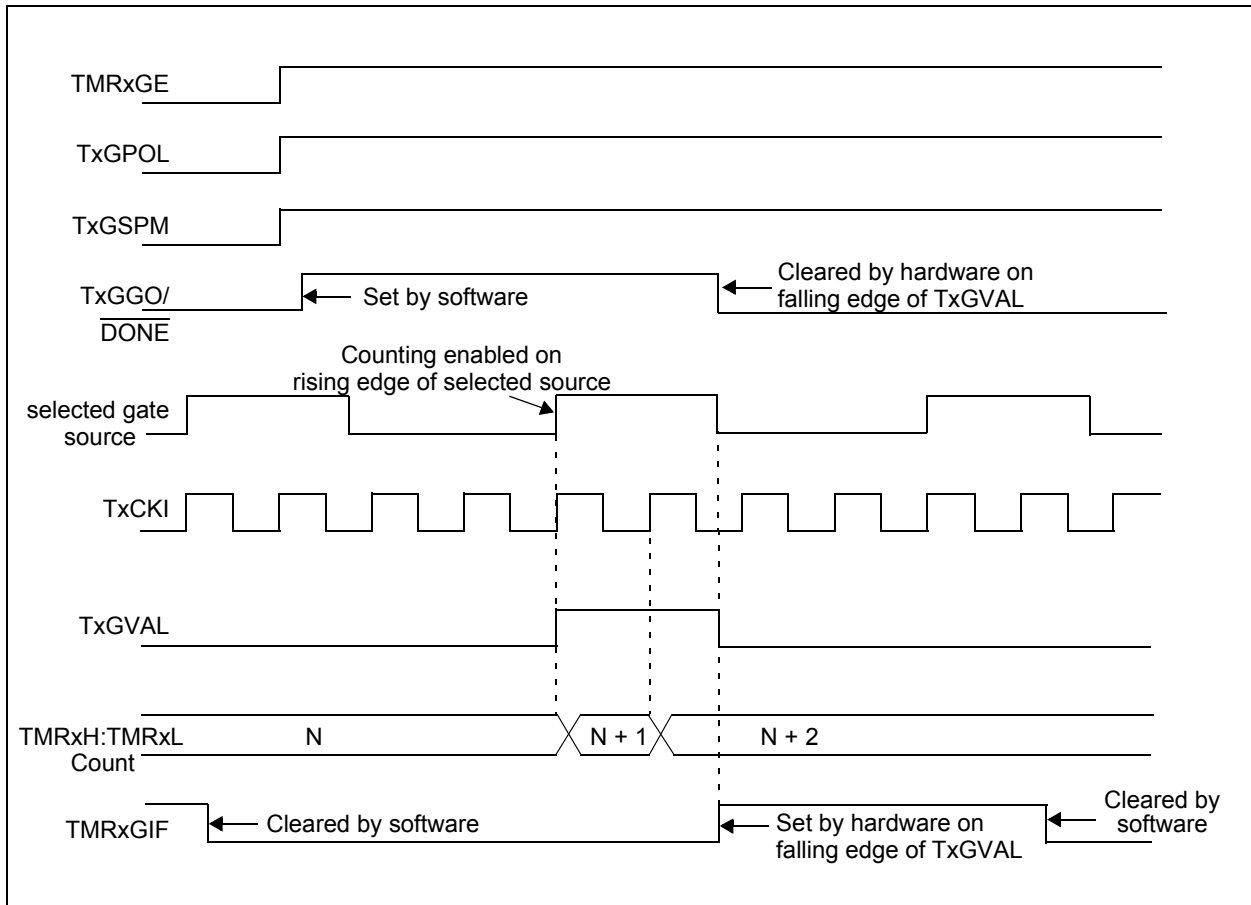


FIGURE 26-5: TIMER1 GATE SINGLE-PULSE MODE



27.5.8 LEVEL RESET, EDGE-TRIGGERED HARDWARE LIMIT ONE-SHOT MODES

In Level -Triggered One-Shot mode the timer count is reset on the external signal level and starts counting on the rising/falling edge of the transition from Reset level to the active level while the ON bit is set. Reset levels are selected as follows:

- Low Reset level (MODE<4:0> = 01110)
- High Reset level (MODE<4:0> = 01111)

When the timer count matches the PRx period count, the timer is reset and the ON bit is cleared. When the ON bit is cleared by either a PRx match or by software control a new external signal edge is required after the ON bit is set to start the counter.

When Level-Triggered Reset One-Shot mode is used in conjunction with the CCP PWM operation the PWM drive goes active with the external signal edge that starts the timer. The PWM drive goes inactive when the timer count equals the CCPRx pulse width count. The PWM drive does not go active when the timer count clears at the PRx period count match.

PIC16(L)F19155/56/75/76/85/86

REGISTER 28-13: SMTxCPWL: SMT CAPTURED PULSE WIDTH REGISTER – LOW BYTE

R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x
SMTxCPW<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **SMTxCPW<7:0>**: Significant bits of the SMT PW Latch – Low Byte

REGISTER 28-14: SMTxCPWH: SMT CAPTURED PULSE WIDTH REGISTER – HIGH BYTE

R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x
SMTxCPW<15:8>							
bit 7				bit 0			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **SMTxCPW<15:8>**: Significant bits of the SMT PW Latch – High Byte

REGISTER 28-15: SMTxCPWU: SMT CAPTURED PULSE WIDTH REGISTER – UPPER BYTE

R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x	R-x/x
SMTxCPW<23:16>							
bit 7				bit 0			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **SMTxCPW<23:16>**: Significant bits of the SMT PW Latch – Upper Byte

29.2.1 CCPX PIN CONFIGURATION

The software must configure the CCPx pin as an output by clearing the associated TRIS bit and defining the appropriate output pin through the RxyPPS registers. See **Section 15.0 “Peripheral Pin Select (PPS) Module”** for more details.

The CCP output can also be used as an input for other peripherals.

Note: Clearing the CCPxCON register will force the CCPx compare output latch to the default low level. This is not the PORT I/O data latch.

29.2.2 TIMER1 MODE RESOURCE

In Compare mode, Timer1 must be running in either Timer mode or Synchronized Counter mode. The compare operation may not work in Asynchronous Counter mode.

See **Section 26.0 “Timer1 Module with Gate Control”** for more information on configuring Timer1.

Note: Clocking Timer1 from the system clock (Fosc) should not be used in Compare mode. In order for Compare mode to recognize the trigger event on the CCPx pin, Timer1 must be clocked from the instruction clock (Fosc/4) or from an external clock source.

29.2.3 AUTO-CONVERSION TRIGGER

All CCPx modes set the CCP interrupt flag (CCPxFIF). When this flag is set and a match occurs, an Auto-conversion Trigger can take place if the CCP module is selected as the conversion trigger source.

Refer to **Section 19.2.6 “ADC Conversion Procedure (Basic Mode)”** for more information.

Note: Removing the match condition by changing the contents of the CCPRxH and CCPRxL register pair, between the clock edge that generates the Auto-conversion Trigger and the clock edge that generates the Timer1 Reset, will preclude the Reset from occurring

29.2.4 COMPARE DURING SLEEP

Since Fosc is shut down during Sleep mode, the Compare mode will not function properly during Sleep, unless the timer is running. The device will wake on interrupt (if enabled).

29.3 PWM Overview

Pulse-Width Modulation (PWM) is a scheme that provides power to a load by switching quickly between fully on and fully off states. The PWM signal resembles a square wave where the high portion of the signal is considered the on state and the low portion of the signal is considered the off state. The high portion, also known as the pulse width, can vary in time and is defined in steps. A larger number of steps applied, which lengthens the pulse width, also supplies more power to the load. Lowering the number of steps applied, which shortens the pulse width, supplies less power. The PWM period is defined as the duration of one complete cycle or the total amount of on and off time combined.

PWM resolution defines the maximum number of steps that can be present in a single PWM period. A higher resolution allows for more precise control of the pulse width time and in turn the power that is applied to the load.

The term duty cycle describes the proportion of the on time to the off time and is expressed in percentages, where 0% is fully off and 100% is fully on. A lower duty cycle corresponds to less power applied and a higher duty cycle corresponds to more power applied.

Figure 29-3 shows a typical waveform of the PWM signal.

29.3.1 STANDARD PWM OPERATION

The standard PWM mode generates a Pulse-Width Modulation (PWM) signal on the CCPx pin with up to ten bits of resolution. The period, duty cycle, and resolution are controlled by the following registers:

- PR2 registers
- T2CON registers
- CCPRxL registers
- CCPxCON registers

Figure 29-4 shows a simplified block diagram of PWM operation.

Note: The corresponding TRIS bit must be cleared to enable the PWM output on the CCPx pin.

FIGURE 29-3: CCP PWM OUTPUT SIGNAL

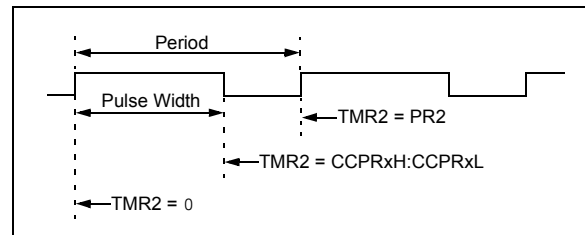


FIGURE 33-34: BUS COLLISION DURING START CONDITION (SCL = 0)

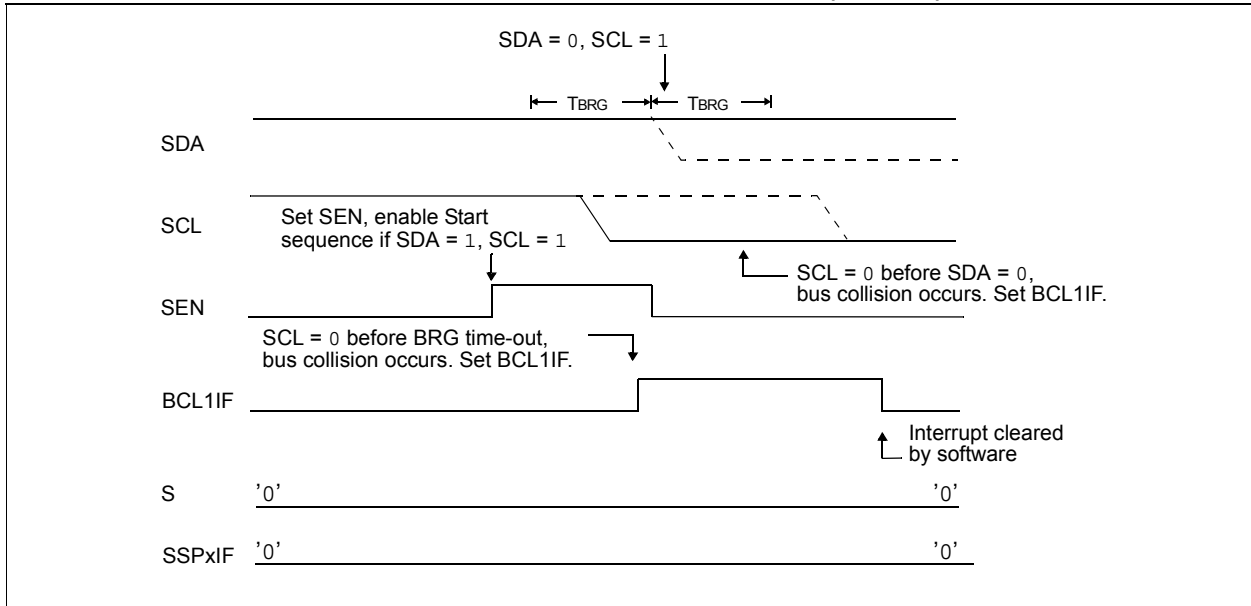
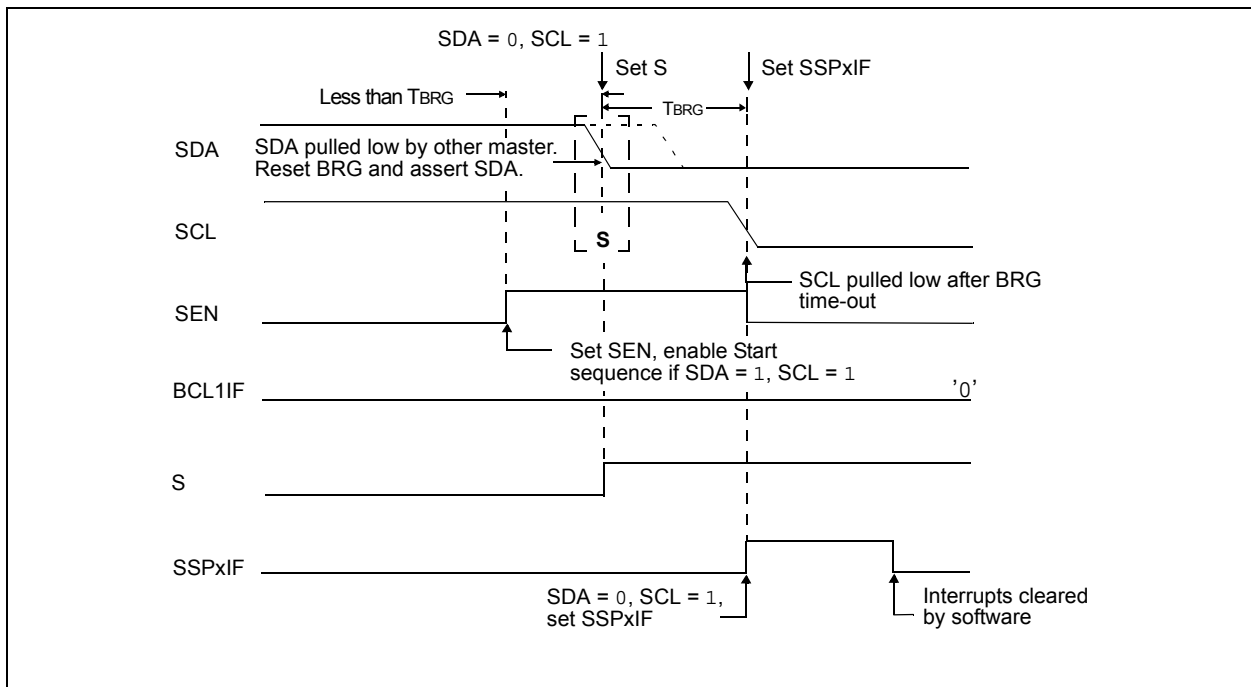


FIGURE 33-35: BRG RESET DUE TO SDA ARBITRATION DURING START CONDITION



PIC16(L)F19155/56/75/76/85/86

REGISTER 33-2: SSPxCON1: SSPx CONTROL REGISTER 1

R/C/HS-0/0	R/C/HS-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
WCOL	SSPOV ⁽¹⁾	SSPEN	CKP	SSPM<3:0>			
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Bit is set by hardware
		C = User cleared

- bit 7 **WCOL:** Write Collision Detect bit (Transmit mode only)
1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
0 = No collision
- bit 6 **SSPOV:** Receive Overflow Indicator bit⁽¹⁾
In SPI mode:
1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. In Slave mode, the user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow. In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register (must be cleared in software).
0 = No overflow
In I²C mode:
1 = A byte is received while the SSPxBUF register is still holding the previous byte. SSPOV is a "don't care" in Transmit mode (must be cleared in software).
0 = No overflow
- bit 5 **SSPEN:** Synchronous Serial Port Enable bit
In both modes, when enabled, the following pins must be properly configured as input or output
In SPI mode:
1 = Enables serial port and configures SCK, SDO, SDI and \overline{SS} as the source of the serial port pins⁽²⁾
0 = Disables serial port and configures these pins as I/O port pins
In I²C mode:
1 = Enables the serial port and configures the SDA and SCL pins as the source of the serial port pins⁽³⁾
0 = Disables serial port and configures these pins as I/O port pins
- bit 4 **CKP:** Clock Polarity Select bit
In SPI mode:
1 = Idle state for clock is a high level
0 = Idle state for clock is a low level
In I²C Slave mode:
SCL release control
1 = Enable clock
0 = Holds clock low (clock stretch). (Used to ensure data setup time.)
In I²C Master mode:
Unused in this mode
- bit 3-0 **SSPM<3:0>:** Synchronous Serial Port Mode Select bits
1111 = I²C Slave mode, 10-bit address with Start and Stop bit interrupts enabled
1110 = I²C Slave mode, 7-bit address with Start and Stop bit interrupts enabled
1101 = Reserved
1100 = Reserved
1011 = I²C firmware controlled Master mode (slave idle)
1010 = SPI Master mode, clock = $F_{osc}/(4 * (SSPxADD+1))$ ⁽⁵⁾
1001 = Reserved
1000 = I²C Master mode, clock = $F_{osc} / (4 * (SSPxADD+1))$ ⁽⁴⁾
0111 = I²C Slave mode, 10-bit address
0110 = I²C Slave mode, 7-bit address
0101 = SPI Slave mode, clock = SCK pin, \overline{SS} pin control disabled, \overline{SS} can be used as I/O pin
0100 = SPI Slave mode, clock = SCK pin, \overline{SS} pin control enabled
0011 = SPI Master mode, clock = $T2_match/2$
0010 = SPI Master mode, clock = $F_{osc}/64$
0001 = SPI Master mode, clock = $F_{osc}/16$
0000 = SPI Master mode, clock = $F_{osc}/4$

- Note**
- 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.
 - 2: When enabled, these pins must be properly configured as input or output. Use SSPxSSPPS, SSPxCLKPPS, SSPxDATPPS, and RxyPPS to select the pins.
 - 3: When enabled, the SDA and SCL pins must be configured as inputs. Use SSPxCLKPPS, SSPxDATPPS, and RxyPPS to select the pins.
 - 4: SSPxADD values of 0, 1 or 2 are not supported for I²C mode.
 - 5: SSPxADD value of '0' is not supported. Use SSPM = 0000 instead.

PIC16(L)F19155/56/75/76/85/86

REGISTER 33-4: SSPxCON3: SSPx CONTROL REGISTER 3

R-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ACKTIM ⁽³⁾	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

- bit 7 **ACKTIM:** Acknowledge Time Status bit (I²C mode only)⁽³⁾
1 = Indicates the I²C bus is in an Acknowledge sequence, set on 8th falling edge of SCL clock
0 = Not an Acknowledge sequence, cleared on 9th rising edge of SCL clock
- bit 6 **PCIE:** Stop Condition Interrupt Enable bit (I²C mode only)
1 = Enable interrupt on detection of Stop condition
0 = Stop detection interrupts are disabled⁽²⁾
- bit 5 **SCIE:** Start Condition Interrupt Enable bit (I²C mode only)
1 = Enable interrupt on detection of Start or Restart conditions
0 = Start detection interrupts are disabled⁽²⁾
- bit 4 **BOEN:** Buffer Overwrite Enable bit
In SPI Slave mode:⁽¹⁾
1 = SSPxBUF updates every time that a new data byte is shifted in ignoring the BF bit
0 = If new byte is received with BF bit of the SSPxSTAT register already set, SSPOV bit of the SSPxCON1 register is set, and the buffer is not updated
In I²C Master mode and SPI Master mode:
This bit is ignored.
In I²C Slave mode:
1 = SSPxBUF is updated and ACK is generated for a received address/data byte, ignoring the state of the SSPOV bit only if the BF bit = 0.
0 = SSPxBUF is only updated when SSPOV is clear
- bit 3 **SDAHT:** SDA Hold Time Selection bit (I²C mode only)
1 = Minimum of 300 ns hold time on SDA after the falling edge of SCL
0 = Minimum of 100 ns hold time on SDA after the falling edge of SCL
- bit 2 **SBCDE:** Slave Mode Bus Collision Detect Enable bit (I²C Slave mode only)
If, on the rising edge of SCL, SDA is sampled low when the module is outputting a high state, the BCL1IF bit of the PIR3 register is set, and bus goes idle
1 = Enable slave bus collision interrupts
0 = Slave bus collision interrupts are disabled
- bit 1 **AHEN:** Address Hold Enable bit (I²C Slave mode only)
1 = Following the eighth falling edge of SCL for a matching received address byte; CKP bit of the SSPxCON1 register will be cleared and the SCL will be held low.
0 = Address holding is disabled
- bit 0 **DHEN:** Data Hold Enable bit (I²C Slave mode only)
1 = Following the eighth falling edge of SCL for a received data byte; slave hardware clears the CKP bit of the SSPxCON1 register and SCL is held low.
0 = Data holding is disabled

- Note 1:** For daisy-chained SPI operation; allows the user to ignore all but the last received byte. SSPOV is still set when a new byte is received and BF = 1, but hardware continues to write the most recent byte to SSPxBUF.
- 2:** This bit has no effect in Slave modes that Start and Stop condition detection is explicitly listed as enabled.
- 3:** The ACKTIM Status bit is only active when the AHEN bit or DHEN bit is set.

34.5 EUSART Operation During Sleep

The EUSART will remain active during Sleep only in the Synchronous Slave mode. All other modes require the system clock and therefore cannot generate the necessary signals to run the Transmit or Receive Shift registers during Sleep.

Synchronous Slave mode uses an externally generated clock to run the Transmit and Receive Shift registers.

34.5.1 SYNCHRONOUS RECEIVE DURING SLEEP

To receive during Sleep, all the following conditions must be met before entering Sleep mode:

- RCxSTA and TXxSTA Control registers must be configured for Synchronous Slave Reception (see **Section 34.4.2.4 “Synchronous Slave Reception Set-up:”**).
- If interrupts are desired, set the RXxIE bit of the PIE3 register and the GIE and PEIE bits of the INTCON register.
- The RXxIF interrupt flag must be cleared by reading RCxREG to unload any pending characters in the receive buffer.

Upon entering Sleep mode, the device will be ready to accept data and clocks on the RX/DT and TX/CK pins, respectively. When the data word has been completely clocked in by the external device, the RXxIF interrupt flag bit of the PIR3 register will be set. Thereby, waking the processor from Sleep.

Upon waking from Sleep, the instruction following the `SLEEP` instruction will be executed. If the Global Interrupt Enable (GIE) bit of the INTCON register is also set, then the Interrupt Service Routine at address 004h will be called.

34.5.2 SYNCHRONOUS TRANSMIT DURING SLEEP

To transmit during Sleep, all the following conditions must be met before entering Sleep mode:

- The RCxSTA and TXxSTA Control registers must be configured for synchronous slave transmission (see **Section 34.4.2.2 “Synchronous Slave Transmission Set-up:”**).
- The TXxIF interrupt flag must be cleared by writing the output data to the TXxREG, thereby filling the TSR and transmit buffer.
- If interrupts are desired, set the TXxIE bit of the PIE3 register and the PEIE bit of the INTCON register.
- Interrupt enable bits TXxIE of the PIE3 register and PEIE of the INTCON register must set.

Upon entering Sleep mode, the device will be ready to accept clocks on TX/CK pin and transmit data on the RX/DT pin. When the data word in the TSR has been completely clocked out by the external device, the pending byte in the TXxREG will transfer to the TSR and the TXxIF flag will be set. Thereby, waking the processor from Sleep. At this point, the TXxREG is available to accept another character for transmission, which will clear the TXxIF flag.

Upon waking from Sleep, the instruction following the `SLEEP` instruction will be executed. If the Global Interrupt Enable (GIE) bit is also set then the Interrupt Service Routine at address 0004h will be called.

39.4 AC Characteristics

FIGURE 39-4: LOAD CONDITIONS

